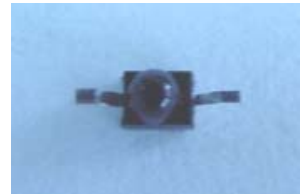




Technical Data Sheet

1.9mm Round Subminiature “Z-Bend” Lead Phototransistor

PT91-21B/F10



Features

- Fast response time
- High photo sensitivity
- Small junction capacitance
- Compatible with infrared and vapor phase reflow solder process.
- Pb free

Descriptions

- PT91-21B/F10 is a phototransistor in miniature SMD package which is molded in black plastic with spherical top view lens. The device is spectrally matched to infrared emitting diode.

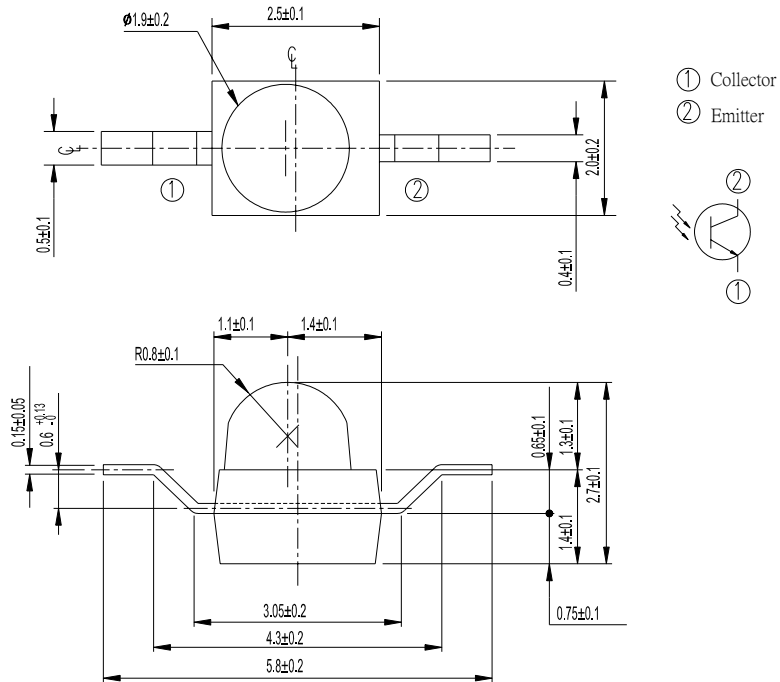
Applications

- Miniature switch
- Counters and sorter
- Position sensor
- Infrared applied system

Device Selection Guide

| LED Part No. | Chip | Lens Color |
|--------------|----------|------------|
| | Material | |
| PT | Silicon | Black |

Package Dimensions



- Notes:** 1.All dimensions are in millimeters
2.Tolerances unless dimensions ± 0.1 mm

Absolute Maximum Ratings ($T_a=25^\circ\text{C}$)

| Parameter | Symbol | Rating | Units |
|--|-----------|-----------|------------------|
| Collector-Emitter Voltage | V_{CEO} | 30 | V |
| Emitter-Collector-Voltage | V_{ECO} | 5 | V |
| Collector Current | I_C | 20 | mA |
| Operating Temperature | T_{opr} | -25 ~ +85 | $^\circ\text{C}$ |
| Storage Temperature | T_{stg} | -40 ~ +85 | $^\circ\text{C}$ |
| Soldering Temperature | T_{sol} | 260 | $^\circ\text{C}$ |
| Power Dissipation at(or below) 25 $^\circ\text{C}$ Free Air Temperature | P_c | 75 | mW |

Notes: *1:Soldering time ≤ 5 seconds.

Electro-Optical Characteristics (Ta=25°C)

| Parameter | Symbol | Condition | Min | Typ | Max | Unit |
|--------------------------------------|-----------------|--|-----|-----|------|---------|
| Rang Of Spectral Bandwidth | $\lambda_{0.5}$ | --- | 730 | --- | 1100 | nm |
| Wavelength Of Peak Sensitivity | λ_p | --- | --- | 940 | --- | nm |
| Collector-Emitter Breakdown Voltage | $B_{V_{CEO}}$ | $I_C=100\mu A$ $E_e=0mW/cm^2$ | 30 | --- | --- | V |
| Emitter-Collector Breakdown Voltage | $B_{V_{ECO}}$ | $I_E=100\mu A$ $E_e=0mW/cm^2$ | 5 | --- | --- | V |
| Collector-Emitter Saturation Voltage | $V_{CE(sat)}$ | $I_C=2mA$ $E_e=1mW/cm^2$ | --- | --- | 0.4 | V |
| Collector Dark Current | I_{CEO} | $V_{CE}=20V$ $E_e=0mW/cm^2$ | --- | --- | 100 | nA |
| On State Collector Current | $I_{C(ON)}$ | $V_{CE}=5V$ $E_e=1mW/cm^2$ | 1.0 | 1.5 | | mA |
| Rise Time | t_r | $V_{CE}=5V$ $I_C=1mA$ $R_L=1000\Omega$ | --- | 15 | --- | μS |
| Fall Time | t_f | | --- | 15 | --- | |

Typical Electro-Optical Characteristics Curves

Fig.1 Collector Power Dissipation vs. Ambient Temperature

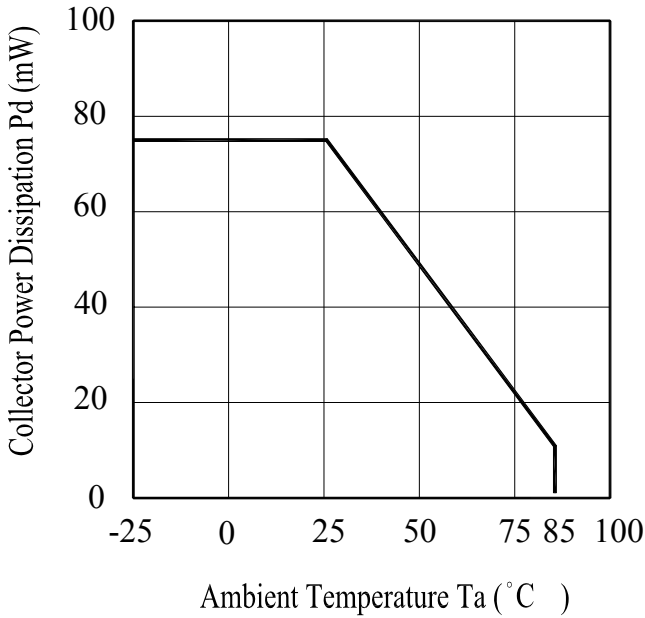


Fig.2 Spectral Sensitivity

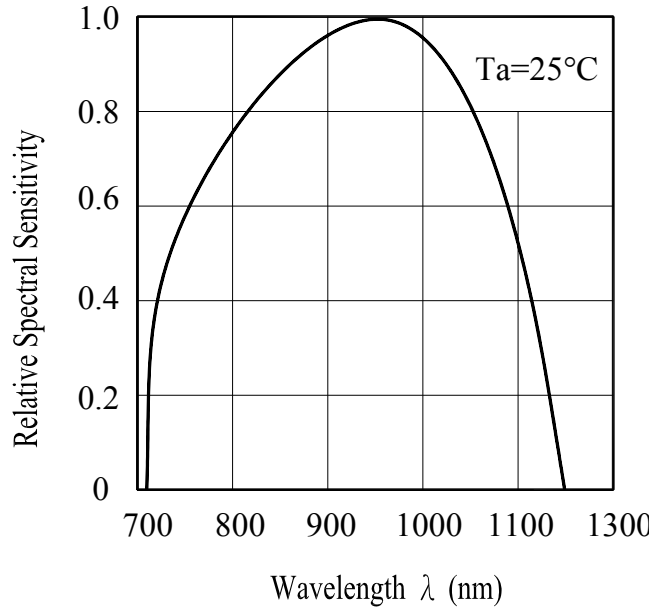


Fig.3 Relative Collector Current vs. Ambient Temperature

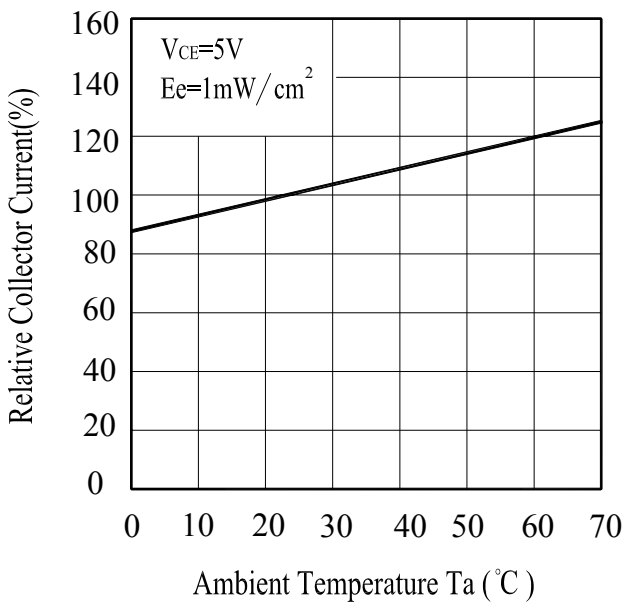
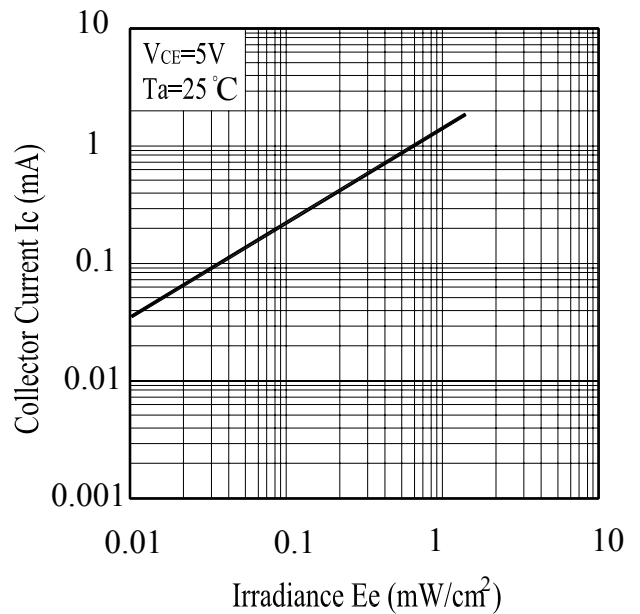


Fig.4 Collector Current vs. Irradiance



Typical Electro-Optical Characteristics Curves

Fig.5 Collector Dark Current vs. Ambient Temperature

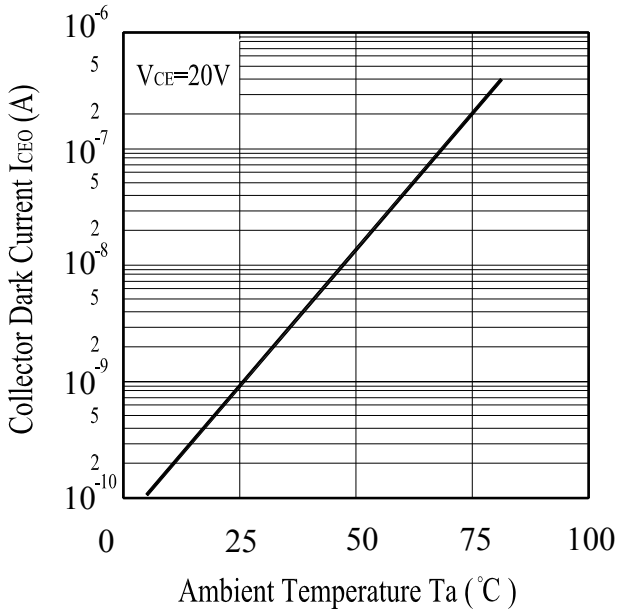
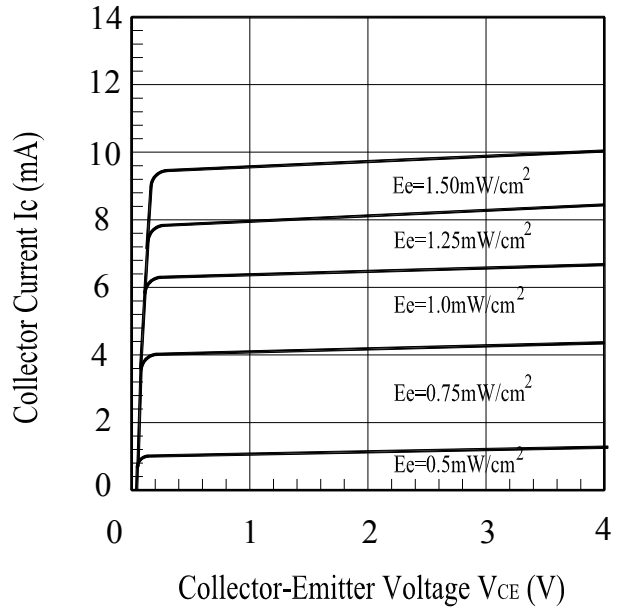


Fig.6 Collector Current vs. Collector-Emitter Voltage



Precautions For Use

1. Over-current-proof

Customer must apply resistors for protection , otherwise slight voltage shift will cause big current change (Burn out will happen).

2. Storage

2.1 Do not open moisture proof bag before the products are ready to use.

2.2 Before opening the package, the LEDs should be kept at 30°C or less and 90%RH or less.

2.3 The LEDs should be used within a year.

2.4 After opening the package, the LEDs should be kept at 30°C or less and 70%RH or less.

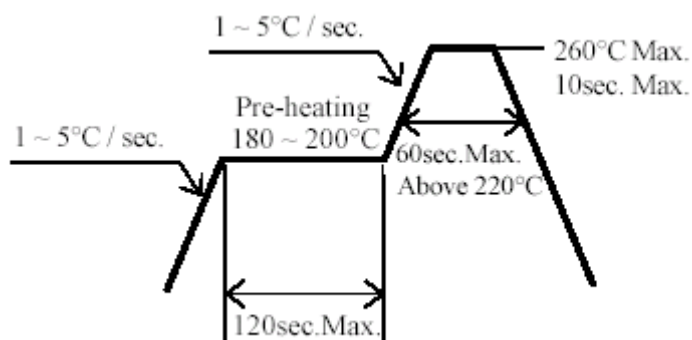
2.5 The LEDs should be used within 168 hours (7 days) after opening the package.

2.6 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment : 60±5°C for 24 hours.

3. Soldering Condition

3.1 Pb-free solder temperature profile



3.2 Reflow soldering should not be done more than two times.

3.3 When soldering, do not put stress on the LEDs during heating.

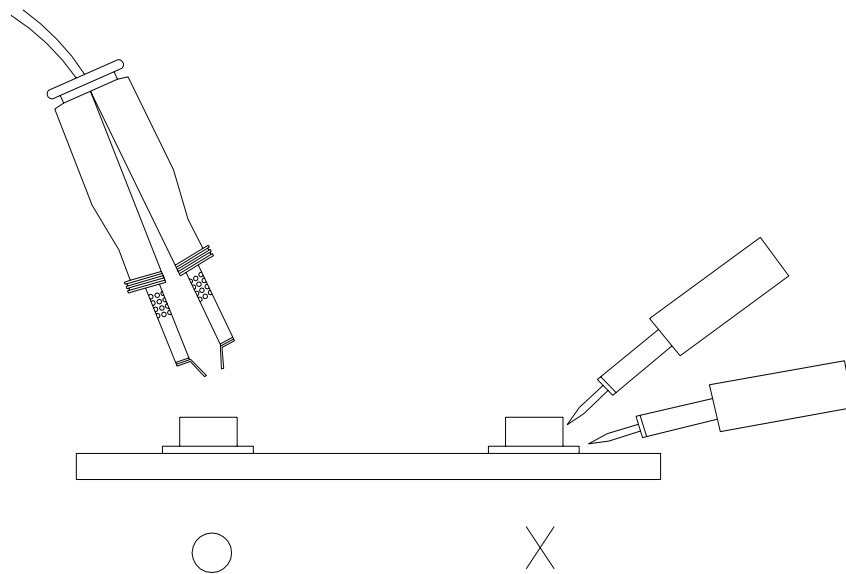
3.4 After soldering, do not warp the circuit board.

4.Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 280°C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



Reliability Test Item And Condition

The reliability of products shall be satisfied with items listed below.

Confidence level : 90%

LTPD : 10%

| NO. | Item | Test Conditions | Test Hours/ Cycles | Sample Sizes | Failure Judgement Criteria | Ac/Re |
|-----|------------------------------------|--|-----------------------|-----------------|--|-------|
| 1 | REFLOW Soldering | TEMP. : 260°C±5°C 5secs | 6Mins | 22pcs | $I_{C(ON)} \leq L \times 0.8$ L : Lower Specification Limit | 0/1 |
| 2 | Temperature Cycle | H : +100°C 15mins \updownarrow 5mins \updownarrow L : -40°C 15mins | 50Cycles | 22pcs | | 0/1 |
| 3 | Thermal Shock | H : +100°C 5mins \updownarrow 10secs \updownarrow L : -10°C 5mins | 50Cycles | 22pcs | | 0/1 |
| 4 | High Temperature Storage | TEMP. : +100°C | 1000hrs | 22pcs | | 0/1 |
| 5 | Low Temperature Storage | TEMP. : -40°C | 1000hrs | 22pcs | | 0/1 |
| 6 | DC Operating Life | $V_{CE}=5V$ | 1000hrs | 22pcs | | 0/1 |
| 7 | High Temperature/ High Humidity | 85°C / 85% R.H | 1000hrs | 22pcs | | 0/1 |



PT91-21B/F10

Packing Quantity Specification

- 1.1000PCS/1Bag , 20Bags/1Box
- 2.10Boxes/1Carton

Label Form Specification



CPN: Customer's Production Number
P/N : Production Number
QTY: Packing Quantity
CAT: Ranks
HUE: Peak Wavelength
REF: Reference
LOT No: Lot Number
MADE IN TAIWAN: Production Place

Notes

1. Above specification may be changed without notice. EVERLIGHT will reserve authority on material change for above specification.
2. When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. EVERLIGHT assumes no responsibility for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
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